

# LUDZS15BT1G

## S-LUDZS15BT1G

Zener Voltage Regulators  
200 mW SOD-323 Surface Mount



### 1. FEATURES

- We declare that the material of product compliance with RoHS requirements and Halogen Free.
- S- prefix for automotive and other applications requiring unique site and control change requirements; AEC-Q101 qualified and PPAP capable.
- Silicon epitaxial planar

### 2. DEVICE MARKING AND ORDERING INFORMATION

| Device      | Marking | Shipping        |
|-------------|---------|-----------------|
| LUDZS15BT1G | 45      | 3000/Tape&Reel  |
| LUDZS15BT3G | 45      | 10000/Tape&Reel |

### 3. MAXIMUM RATINGS (Ta = 25°C)

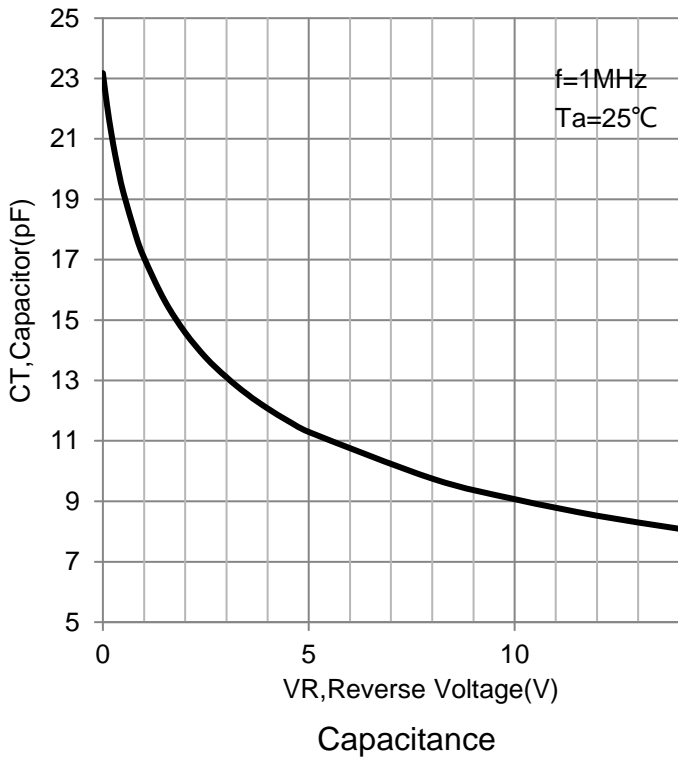
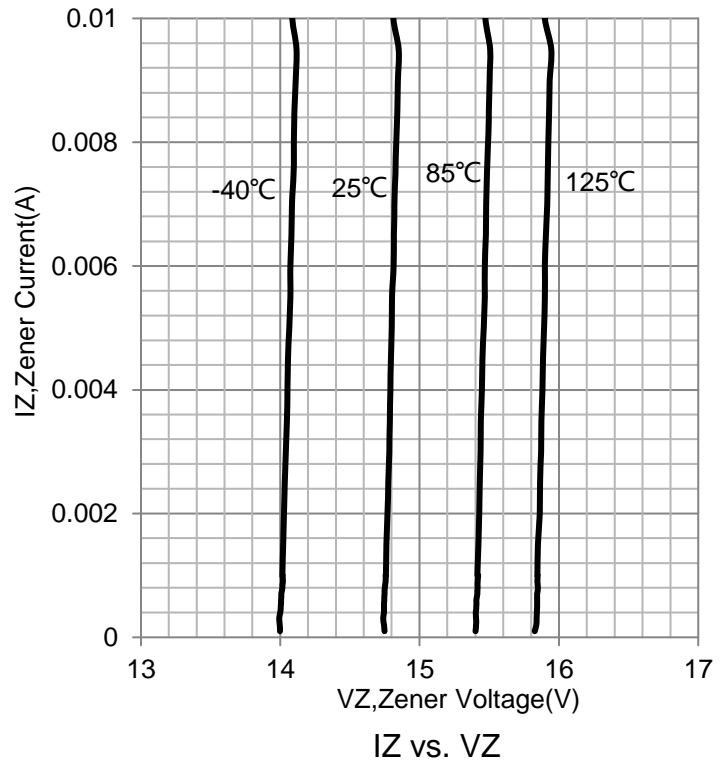
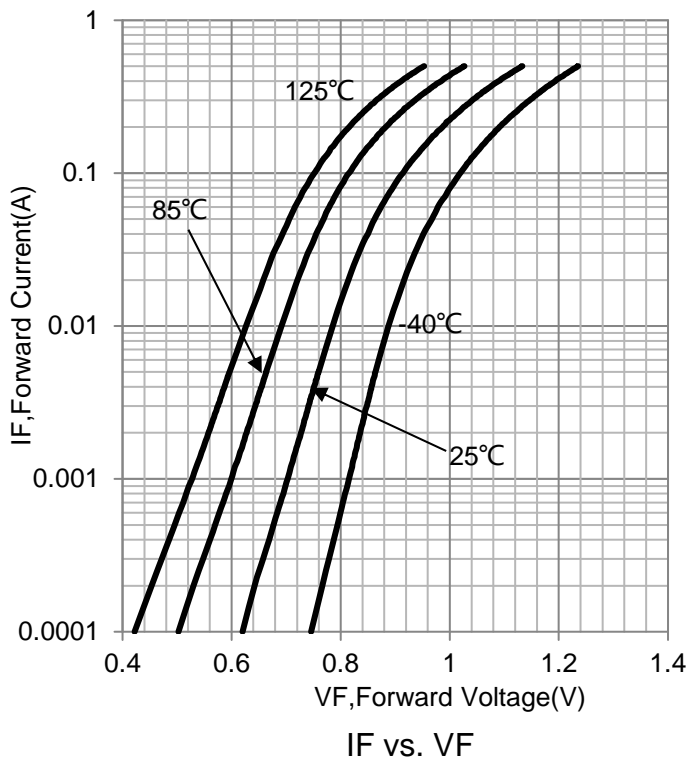
| Parameter   | Symbol  | Limits      | Unit        |
|---|---------|-------------|-------------|
| Total Device Dissipation,<br>FR-5 Board (Note 1) @ TA = 25°C<br>Derate above 25°C | PD      | 200<br>1.57 | mW<br>mW/°C |
| Thermal Resistance,<br>Junction-to-Ambient(Note 1)                                | RθJA    | 635         | °C/W        |
| Junction and Storage temperature  | TJ,Tstg | -55~+150    | °C          |

### 4. ELECTRICAL CHARACTERISTICS (Ta= 25°C)

| Characteristic                             | Symbol | Min.  | Typ. | Max.  | Unit |
|--|--------|-------|------|-------|------|
| Zener voltage<br>(IZT=5mA)                 | VZ     | 14.34 | -    | 14.98 | V    |
| Operating resistance<br>(IZT=5mA)          | ZZT    | -     | -    | 42    | Ω    |
| Rising operating resistance<br>(IZK=0.5mA) | ZZK    | -     | -    | 80    | Ω    |
| Reverse current<br>(VR=11V)                | IR     | -     | -    | 0.1   | μA   |

1. The Zener voltage (Vz ) is measured 40ms after power is supplied.
2. The operating resistances (Zz , Zzk ) are measured by superimposing a minute alternating current on the regulated current (Iz ).

**5.ELECTRICAL CHARACTERISTICS CURVES**



## 6. OUTLINE AND DIMENSIONS

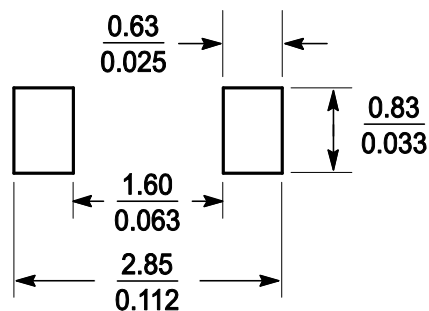
Notes:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.



| DIM | MILLIMETERS |      |       | INCHES   |       |       |
|-----|-------------|------|-------|----------|-------|-------|
|     | MIN         | NOM  | MAX   | MIN      | NOM   | MAX   |
| A   | 0.8         | 0.9  | 1     | 0.031    | 0.035 | 0.04  |
| A1  | 0           | 0.05 | 0.1   | 0        | 0.002 | 0.004 |
| A3  | 0.15REF     |      |       | 0.006REF |       |       |
| b   | 0.25        | 0.32 | 0.4   | 0.01     | 0.012 | 0.016 |
| C   | 0.089       | 0.12 | 0.177 | 0.003    | 0.005 | 0.007 |
| D   | 1.6         | 1.7  | 1.8   | 0.062    | 0.066 | 0.07  |
| E   | 1.15        | 1.25 | 1.35  | 0.045    | 0.049 | 0.053 |
| L   | 0.08        |      |       | 0.003    |       |       |
| HE  | 2.3         | 2.5  | 2.7   | 0.09     | 0.098 | 0.105 |

## 7. SOLDERING FOOTPRINT



单击下面可查看定价，库存，交付和生命周期等信息

[>>LRC\(乐山无线电\)](#)